

#### 2-wide 3-Input, 2-wide 2-Input AND-OR-Invert Gate IC in bare die form

Rev 1.1 24/01/24

#### Description

The 54ALS51 is fabricated using a 2µm 40V Bipolar process. The device consists of two independent combinations of gates each performing the logic AND-OR-INVERT function. The IC integrates one 2-wide 3-input gates and one 2-wide 2-input gates each performing Boolean functions  $1Y = (1A \cdot 1B \cdot 1C) + (1D \cdot 1E \cdot 1F)$  and  $2Y = (2A \cdot 2B) + (2C \cdot 2D)$  respectively. All inputs are protected against ESD and excess voltage transients.

#### Features:

- High speed 14ns (Max) propagation delay
- Full Military Temperature Range.
- Direct drop-in replacement for obsolete components in long term programs.

#### **Ordering Information**

The following part suffixes apply:

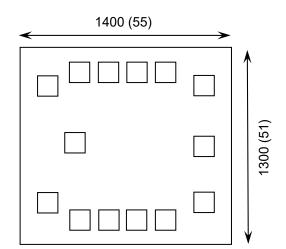
- No suffix MIL-STD-883 /2010B Visual Inspection
- "H" MIL-STD-883 /2010B Visual Inspection+ MIL-PRF-38534 Class H LAT
- "K" MIL-STD-883 /2010A Visual Inspection (Space)+ MIL-PRF-38534 Class K LAT

LAT = Lot Acceptance Test.

For further information on LAT process flows see below.

www.siliconsupplies.com\quality\bare-die-lot-qualification

#### Die Dimensions in µm (mils)



#### **Supply Formats:**

- Default Die in Waffle Pack (400 per tray capacity)
- Sawn Wafer on Tape On request
- Unsawn Wafer On request
- Die Thickness <> 350µm(14 Mils) On request
- Assembled into Ceramic Package On request

#### **Mechanical Specification**

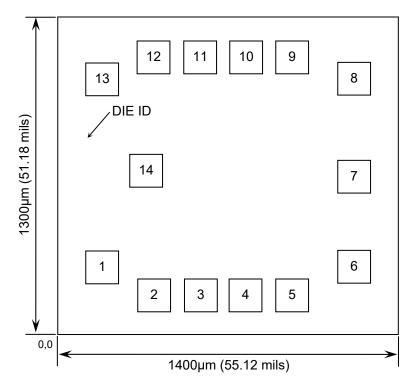
Die Size (Unsawn)	1400 x1300 55 x 51	μm mils	
Minimum Bond Pad Size	130 x 130 5.12 x 5.12	µm mils	
Die Thickness	350 (±20) 13.78 (±0.79)	µm mils	
Top Metal Composition	Al 1%Si 1.1µm		
Back Metal Composition	N/A – Bare Si		





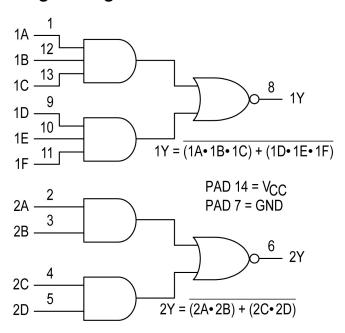
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## Pad Layout and Functions



DAD	PAD FUNCTION	COORDINATES (mm)				
PAD	FUNCTION	X	Y			
1	1A	0.110	0.215			
2	2A	0.325	0.100			
3	2B	0.515	0.100			
4	2C	0.705	0.100			
5	2D	0.895	0.100			
6	2Y	1.150	0.215			
7	GND	1.150	0.585			
8	1Y	1Y 1.150				
9	1D	0.895	1.070			
10	1E 0.705		1.070			
11	1F	0.515	1.070			
12	1B	0.325	1.070			
13	1C	0.110	0.985			
14	V <sub>CC</sub>	0.295	0.610			
CONNECT CHIP BACK TO GND						

## Logic Diagram



#### **Truth Table**

INPUTS						OUTPUT	
1A	1B	1C	1D	1E	1F	1Y	
Н	Н	Н	X	Χ	Х	L	
X	Х	Χ	Н	Н	Н	L	
	All other combinations						
INPUTS						OUTPUT	
2A		2B	2C		2D	2Y	
Н		Н	X X			L	
Х	х х н н						
All other combinations H							
H = High level (steady state)							
L = Low level (steady state) X = don't care							





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## Absolute Maximum Ratings<sup>1</sup>

PARAMETER	SYMBOL	VALUE	UNIT
DC Supply Voltage	V <sub>CC</sub>	7.0	V
DC Input Voltage	V <sub>IN</sub>	7.0	V
Storage Temperature Range	T <sub>STG</sub>	-65 to 150	°C

<sup>1.</sup> Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum ratings, for extended periods, may reduce device reliability.

#### **Recommended Operating Conditions**

	<u> </u>			
PARAMETER	SYMBOL	MIN	MAX	UNITS
Supply Voltage	V <sub>CC</sub>	4.5	5.5	V
High-Level Input Voltage	V <sub>IH</sub>	2	-	V
Low-Level Input Voltage	V <sub>IL</sub>	-	0.7	V
High-Level Output Current	I <sub>OH</sub>	-	-0.4	mA
Low-Level Output Current	I <sub>OL</sub>	-	4	mA
Operating Temperature Range	TJ	-55	+125	°C

## DC Electrical Characteristics<sup>2</sup> T<sub>J</sub> = -55°C to 125°C unless otherwise specified

PARAMETER	SYMBOL	CONDITIONS		LIMITS			UNITS
TANAMETER	OTIVIDOL			MIN	TYP	MAX	JAMITS
Minimum High-Level Input Voltage	V <sub>IH</sub>	-		2	-	-	V
Maximum Low-Level Input Voltage	V <sub>IL</sub>	-		-	-	0.7	V
Input Clamp Diode Voltage	V <sub>IK</sub>	$V_{CC} = MIN$ $I_{IN} = -18mA$		-	-	-1.5	V
Output Voltage High	V <sub>OH</sub>	$V_{CC}$ = MIN, $I_{OH}$ = MAX $V_{IN}$ = $V_{IL}$ or $V_{IH}$ per Truth Table		V <sub>CC</sub> -2	-	-	V
Output Voltage Low	V <sub>OL</sub>	$ \begin{vmatrix} V_{\text{CC}} = V_{\text{CC}} \text{ MIN} \\ I_{\text{OH}} = \text{ MAX} \\ V_{\text{IN}} = V_{\text{IL}} \text{ or } V_{\text{IH}} \\ \text{per Truth Table} \end{vmatrix} I_{\text{OL}} = $	· 4mA	-	0.25	0.4	V
Input Current	I <sub>IN</sub>	$V_{CC} = MAX, V_{IN} = 7.0V$		-	-	0.1	mA
Input High Current	I <sub>IH</sub>	$V_{CC} = MAX, V_{IN} = 2.7V$		-	-	20	μA
Input Low Current	I <sub>IL</sub>	$V_{CC} = MAX, V_{IN} = 0.4V$		-	-	-0.1	mA
Short Circuit Current <sup>3</sup>	I <sub>OS</sub>	V <sub>CC</sub> = MAX		-20	-	-112	mA
Power Supply	loo	V <sub>CC</sub> = MAX ,Output H	ligh	-	-	1.2	mA
Current (Total)	I <sub>CC</sub>	V <sub>CC</sub> = MAX ,Output Low		-	-	1.5	111/7

<sup>2.</sup> All typical values @ V<sub>CC</sub> = 5V, T<sub>J</sub> = 25°C. 3. Not more than one output should be shorted at a time, nor for more than 1 second.





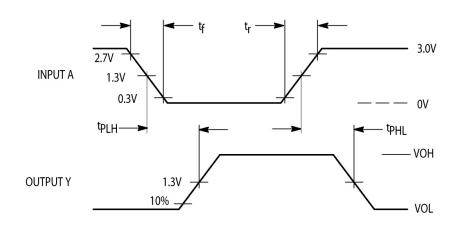
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## AC Electrical Characteristics<sup>4</sup>

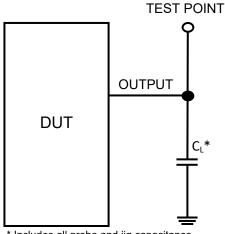
PARAMETER	PARAMETER SYMBOL CONDITIONS	CONDITIONS	LIMITS			UNITS	
TARAMETER	O'IIIBOL	STINDOL GONDITIONS	MIN	TYP	MAX	Oitilo	
Turn-Off Delay, Input to Output	t <sub>PLH</sub>	$V_{CC} = 5V, C_L = 50pF,$ $R_L = 500\Omega$	2	-	14		
Turn-On Delay, Input to Output	t <sub>PHL</sub>	$V_{CC} = 5V, C_{L} = 50pF,$ $R_{L} = 500\Omega$	3	-	12	ns	

<sup>4.</sup> Not production tested in die form, characterized by chip design and tested in package.

#### **Switching Waveform**



#### **Test Circuit**



\* Includes all probe and jig capacitance

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